

Mail Stop: AF
PATENT

8007-1093

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Kiyohito HIROMITSU et al.

Conf. 2651

Application No. 10/537,358

Group 1796

Filed June 3, 2005

Examiner G. Webb

MOLD CLEANING MATERIAL AND MOLD CLEANING METHOD

AFTER FINAL AMENDMENT AND REPLY UNDER 37 C.F.R. § 1.116

Assistant Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

December 9, 2008

Sir:

In response to the final Office Action of November 4, 2008, Applicants herein provide the following amendments and remarks.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begin on page 3 of this paper.

Remarks begin on page 7 of this paper.

12/10/2008 AHONDAF1 00000052 10537358 01 FC:1201 440.00 OP